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LAPIS Technology Co., Ltd.

October 1, 2020

ML62Q1722 Reference Board User's Manual

Issue Date: January 21, 2019

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Preface

This manual describes about the ML62Q1722 Reference Board : RB-D62Q1722GA64.

Refer to following documents when necessary.

- ML62Q1000 Series User's Manual
Provides the detailed information about the microcontroller ML62Q1000 Series.
- EASE1000 User's Manual
Provides the information on how to use the On-chip emulator EASE1000.

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1. Overview

1.1. Features

The ML62Q1722 Reference Board can be used for learning 'how to use' the ML62Q1722, on which the user needs to provide additional external components if necessary. By using the ML62Q1722 Reference Board together with the LAPIS Semiconductor's on-chip emulator EASE1000 and the provided software development environment, the user can develop software, debug and program the Flash.

1.1.1. ML62Q1722 Reference Board features

- The board is provided with ML62Q1722 64pin QFP.
- Mounted with the linked connector to EASE1000.
- Through-holes for connecting the pins of LSI to external peripheral boards.
- Power supply is selectable; supplied from the on-chip emulator EASE1000 or CN1_3pin /CN2_2pin.
- Mounted with LED (P20,P21,P22).
- Mounted with Crystal (32.768KHz)

1.1.2. ML62Q1722 Reference Board Hardware specifications

Table 1 shows the hardware specifications of ML62Q1722 Reference Board.

Table 1 ML62Q1722 Reference Board Hardware specifications

Mounted LSI	U1 : ML62Q1722 64pin QFP
Other Mounted components	PWR: Jumper for selecting the power supply input (3pin pin-header and short pin)
	J1: Jumper for selecting RESET_N pin (3pin pin-header and short pin)
	J2: Jumper for selecting P00/TEST0 pin (3pin pin-header and short pin)
	P20-P22: LEDs
	R1-R3: Resistors for LEDs by P20 to P22
	J3-J5: Jumper Chip for connecting LEDs
	X1, C3, C4: Crystal Oscillator (32.768kHz) and capacitors
	C5-C8: Capacitors for C1, C2, VL1, VL2, and VL3
	CNE: Connector for EASE1000 (14pin connector)
	C1, C2: Capacitors for VDD and VDDL
	R4: Pull-up resistor for RESET_N
Pads (or/and) Through holes for mounting components	CN1-CN2: Connectors for user application system (25pin, 2.54mm pitch, ϕ 0.8mm)
Power check pin	VDD, VSS, UVDD: ϕ 0.8mm
Operating voltage	+1.6V to +5.5V (Supply the VDD with up to 1.8V or higher during power up.)
Board size	55.88 mm x 93.98 mm

For more information about the connection of the mounted components, see the schematic.

1.2. ML62Q1722 Reference Board Outline Diagram

Fig. 1 shows the ML62Q1722 Reference Board.

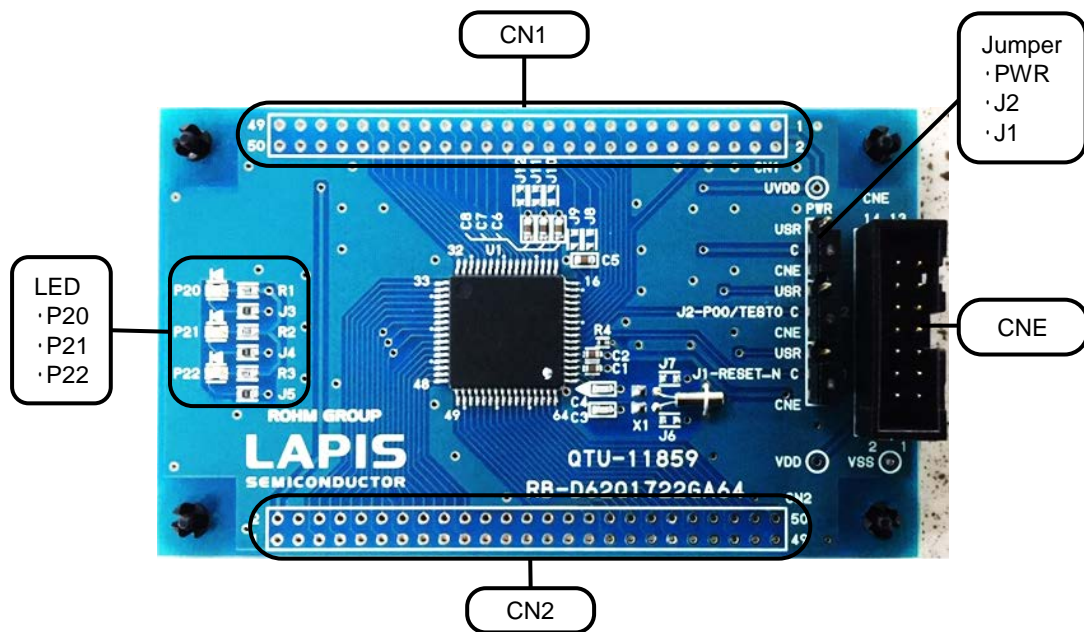


Fig. 1 ML62Q1722 Reference Board Outline Diagram

2. Function of ML62Q1722 Reference Board

2.1. Power Circuit

The input to V_{DD} can be selected from 3.3VOUT of EASE1000 or CN1_3pin / CN2_2pin by PWR jumper.

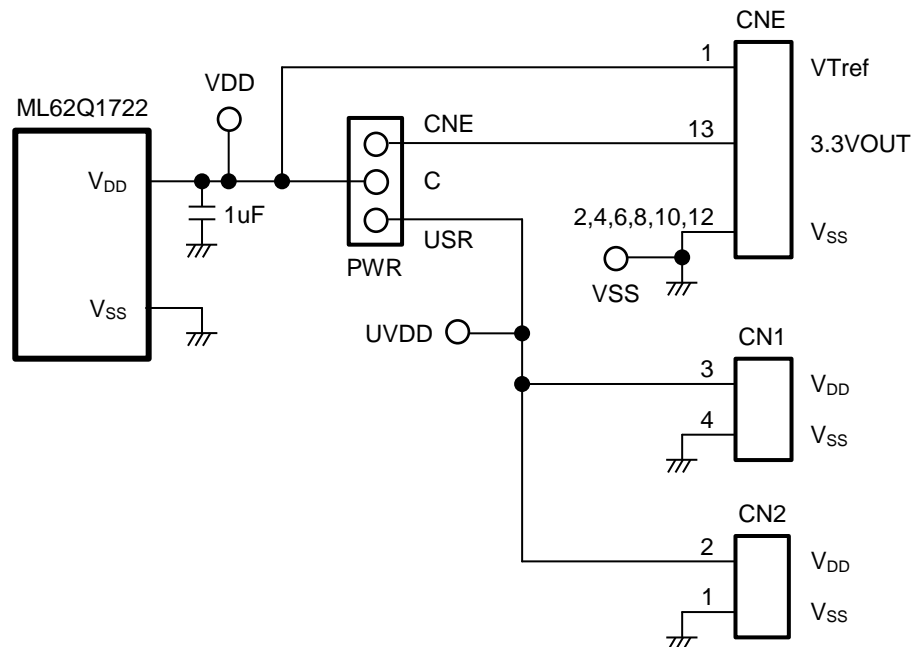


Fig. 2 Power Circuit

[Note]

The power supply ON/OFF procedure in case of setting PWR jumper to the USB-side when using EASE1000.

- The procedure of power supply ON
 1. The USB cable of EASE1000 is connected.
 2. The power supply of user's target system is turned on.
- The procedure of power supply OFF
 1. The power supply of user's target system is turned off
 2. The USB cable of EASE1000 is removed

2.2. Connection for EASE1000 (CNE)

EASE1000 can be used if J1 and J2 jumper are set to “CNE”.

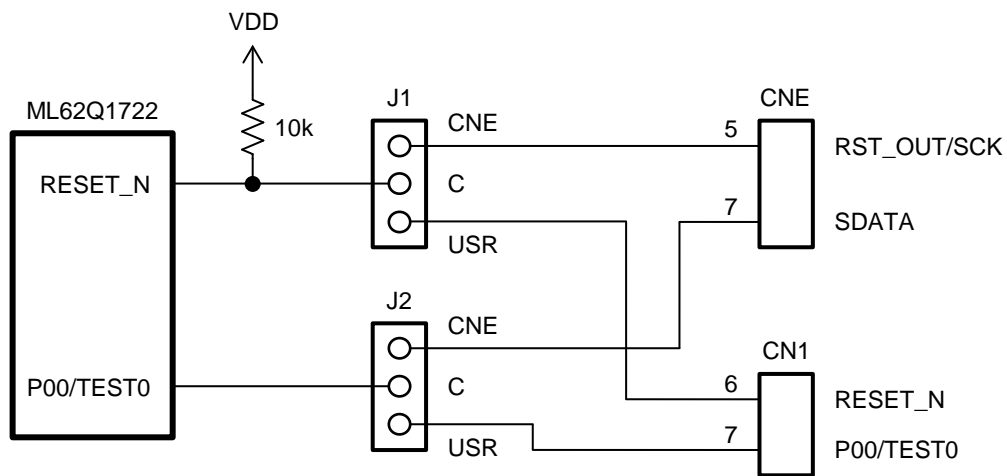


Fig. 3 EASE1000 Interface

[Note]

P00/TEST0 pin:

P00/TEST0 pin of ML62Q1722 is initially set as a pull-up input mode

When using EASE1000, do not set it as an output mode by using an application program, otherwise EASE1000 cannot communicate with the ML62Q1722.

2.3. LED (P20, P21, P22)

The P20-P22 pins of the ML62Q1722 are ports that can directly drive LED. The Ports are connected to the LEDs through jumper-chip. Remove the jumper-chip when not using the LEDs.

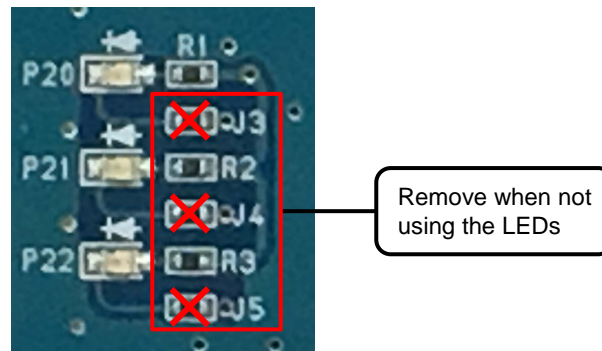


Fig. 4 Jumper-chip removal of LEDs

2.4. XT0/PIO0, XT1/PIO1

ML62Q1722 Reference Borad can be mounted with cylinder type or SMD type crystal oscillator.

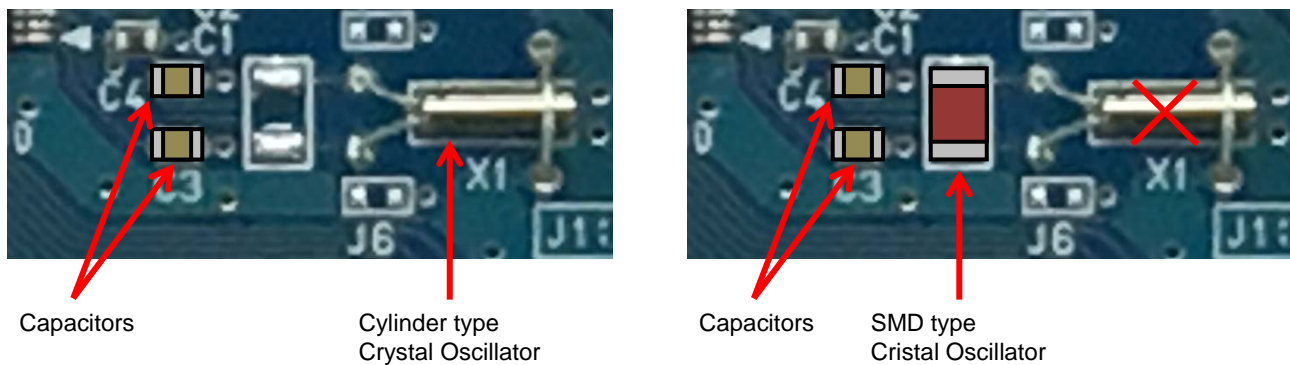


Fig. 5 Example of processing of Crystal Oscillator

2.5. C1, C2, VL1, VL2, VL3

C1, C2, VL1, VL2 and VL3 are connected to capacitor.

ML62Q1722 Reference Board cannot use J8, J9, J10, J11 and J12.

Therefore, please do not mount various parts on J8, J9, J10, J11 and J12.

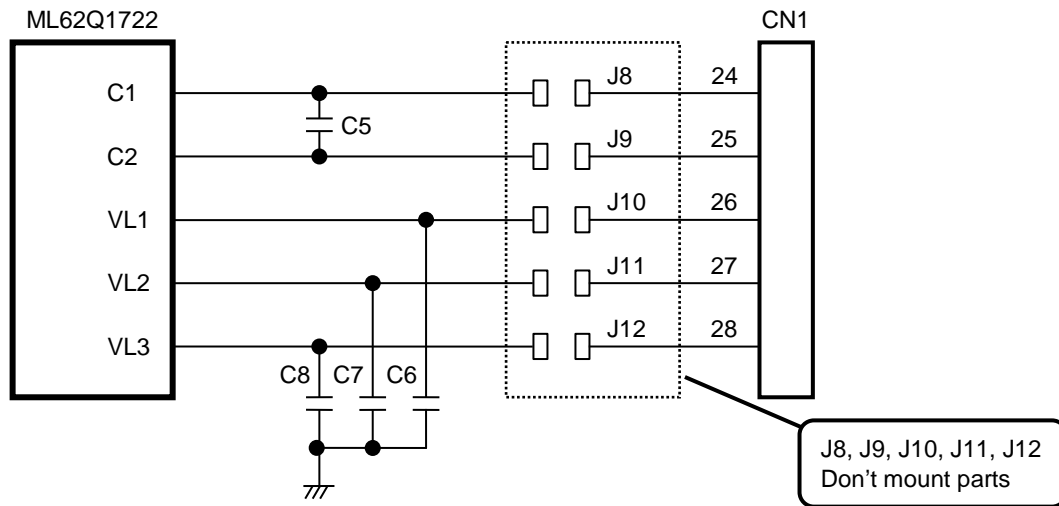


Fig. 6 C1-C2, VL1-VL3 Circuit

3. User Interface

Table 2 shows the pin list of the ML62Q1722 Reference Board user interface connection CN1 and CN2.

Table 2 ML62Q1722 Reference Board CN1/CN2

CN1	NAME	CN1	NAME	CN2	NAME	CN2	NAME
1	XT0/PIO0	26	N.C.	1	VSS	26	N.C.
2	XT1/PIO1	27	N.C.	2	VDD	27	N.C.
3	VDD	28	N.C.	3	N.C.	28	N.C.
4	VSS	29	P70	4	N.C.	29	N.C.
5	N.C.	30	P04	5	P54	30	N.C.
6	RESET_N	31	P05	6	P55	31	N.C.
7	P00/TEST0	32	P06	7	P14	32	P40
8	P01	33	P07	8	P15	33	P41
9	N.C.	34	P10	9	P16	34	P30
10	N.C.	35	P11	10	P17	35	P31
11	N.C.	36	P12	11	P20	36	P32
12	N.C.	37	P13	12	P21	37	P33
13	N.C.	38	P50	13	P22	38	P60
14	N.C.	39	P51	14	P23	39	P61
15	N.C.	40	P52	15	P24	40	P62
16	N.C.	41	P53	16	P25	41	P63
17	P44	42	N.C.	17	P26	42	P64
18	P45	43	N.C.	18	P27	43	P65
19	P02	44	N.C.	19	P56	44	P66
20	P03	45	N.C.	20	P57	45	P67
21	P46	46	N.C.	21	N.C.	46	P42
22	P47	47	N.C.	22	N.C.	47	N.C.
23	N.C.	48	N.C.	23	N.C.	48	N.C.
24	N.C.	49	N.C.	24	N.C.	49	N.C.
25	N.C.	50	N.C.	25	N.C.	50	P43

N.C. : Not Connected

4. Precaution for usage

- (1) The ML62Q1722 Reference Board is an unfinished product and intended for research and development and for expert use in the research and development facility only. The ML62Q1722 Reference Board is not intended to be used for volume production or parts thereof.
- (2) Since the content specified herein is subject to change for improvement without notice, confirm the latest content when using the board.
- (3) See the other documents, the ML62Q1000 series user's manual and EASE1000 user's manual when using the ML62Q1722 Reference Board.
- (4) Confirm the final electrical characteristics by using the mass production parts on your mass production boards.
- (5) LAPIS supports replacing the board for an initial failure soon after the shipment. However LAPIS doesn't support repairing the board.
- (6) ML62Q1722 Reference Board have signal patterns on the underside, it might work abnormally if using on conductive materials. Use it on insulating materials or having any preventable parts.

5.2. ML62Q1722 Reference Board BOM

Table 3 Reference Board BOM

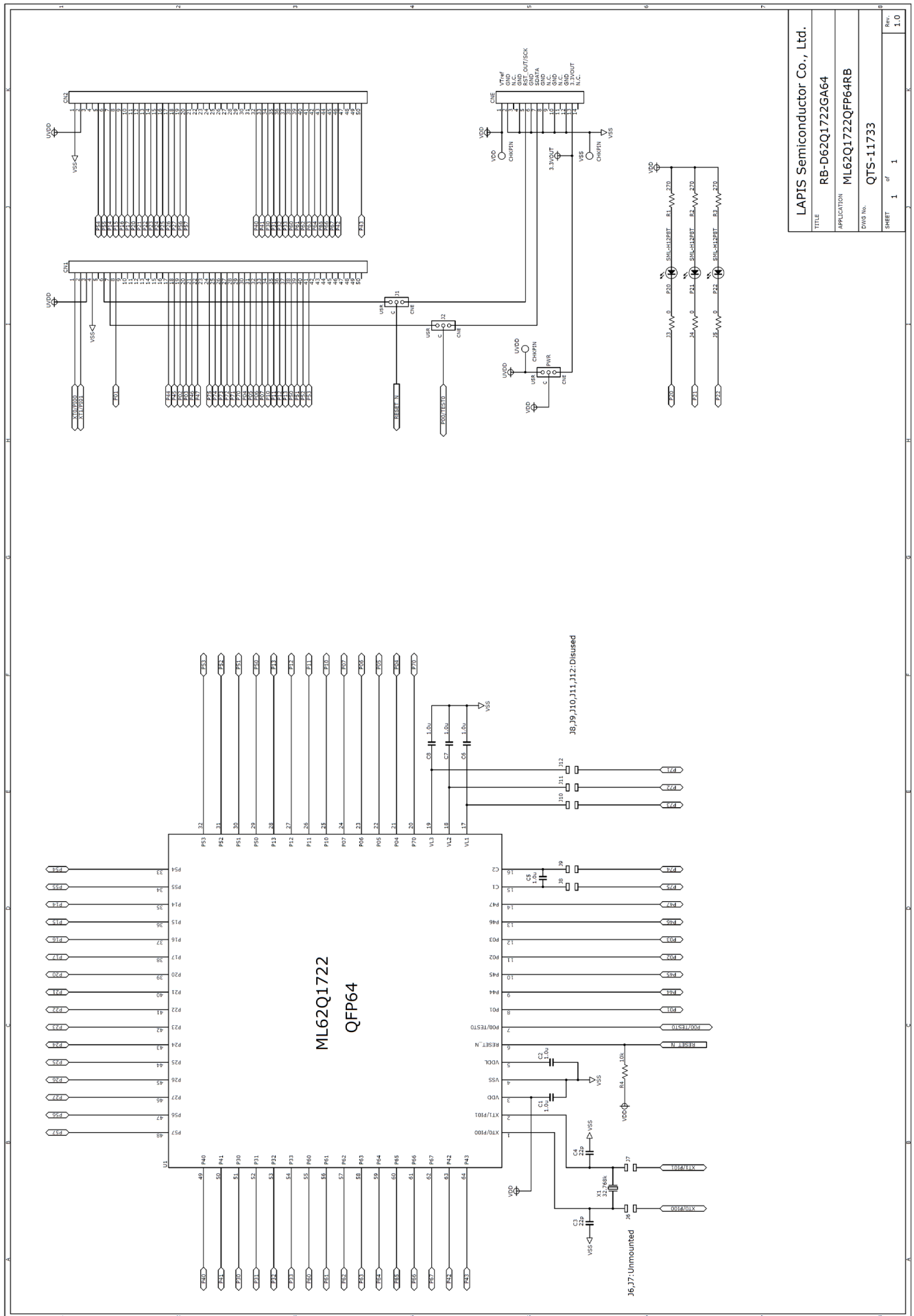
	Parts Number	Silk	Contents	Package Type	Qty.	Maker
1	QTU-11859	RB-D62Q1722GA64	PWB	-	1	LAPIS
2	C1608X7R1E105K	C1, C2, C5, C6, C7, C8	Ceramic Capacitor 1uF/35V	1608(1.6x0.8mm)	6	TDK
3	GRM1885C1H220J	C3, C4	Ceramic Capacitor 22pF/50V	1608(1.6x0.8mm)	2	MURATA
4	HIF3FC-14PA-2.54DSA(71)	CNE	14pin Header Connector	14PIN DIP	1	HIROSE
5	A2-3PA-2.54DSA	J1, J2, PWR	3pin Header Connector	3PIN DIP	3	HIROSE
6	MCR03ERTJ000	J3, J4, J5	Resistor 0Ω	1608(1.6x0.8mm)	3	ROHM
7	SML-H12P8T	P20, P21, P22	LED Green	2012(2.0x1.2mm)	3	ROHM
8	MCR03EZPJ271	R1, R2, R3	Resistor 270Ω	1608(1.6x0.8mm)	3	ROHM
9	MCR01MZPJ103	R4	Resistor 10kΩ	1005(1.0x0.5mm)	1	ROHM
10	ML62Q1722-NNNGA	U1	16-bit Microcontroller	QFP64	1	LAPIS
11	VT-200-F 12.5pF	X1	X'tal 32.768kHz 12.5pF	2PIN	1	SII
12	HIF3GA-2.54SP	-	Short pin	-	3	HIROSE
13	FF013-P3555-AR791	-	Rubber leg, Push rivet	-	4	KOYO FASTENER
14	-	CN1, CN2	Unmounted	50PIN DIP	2	-
15	-	J6, J7, J8, J9, J10, J11, J12	Unmounted	1608(1.6x0.8mm)	7	
16	-	VDD, VSS, UVDD	Unmounted	φ0.8mm	3	

[Note]

- The diameter of through hole of CN1 and CN2 is 0.8 mm.
Using CN1 and CN2, the diameter of connector pin should use the connector below 0.8mm, such as 0.5mm.
- The parts may be changed into another parts with equivalent part special quality.

5.3. ML62Q1722 Reference Board Schematic

The next page shows the schematic of ML62Q1722 Reference Board



LAPIS Semiconductor Co., Ltd.	
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APPLICATION	ML62Q1722QFP64RB
DWG No.	QTS-11733
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